

Rev. V2

Features

- 20 V to 50 V Back Bias
- · 200 mA Sinking Current
- 100 mA Sourcing Current
- Propagation Delay <200 ns Driving 100 pF Capacitive Load
- Low Quiescent Current
- 3.3 V TTL Logic Control
- 3 mm 16-Lead PQFN Package
- Halogen-Free "Green" Mold Compound
- RoHS* Compliant

Description

The MADR-009150 switch driver is designed to work with MACOM's high power and high voltage PIN diode switches. This driver has complementary outputs which can provide up to 200 mA bias current to a SPDT PIN diode switch. The back bias voltage can be selected to be any voltage between 20 V to 50 V. This switch driver can be easily controlled by standard 3.3 V TTL logic. With low quiescent current, this driver has a typical delay of <200 ns when driving 100 pF capacitive load.

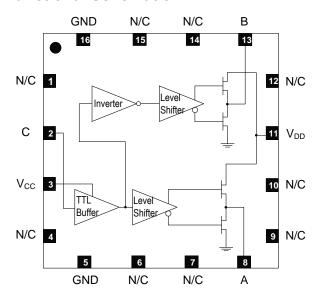
This driver is packaged in a lead free 3 mm 16-lead PQFN package and is available in tape and reel packaging for high volume applications.

Ordering Information¹

| Part Number | Package |
|--------------------|-----------------|
| MADR-009150 | bulk |
| MADR-009150-TR1000 | 1000 Piece Reel |

1. Reference Application Note M513 for reel size information.

Functional Schematic



Pin Configuration

| Pin No. | Function | Description of Function | |
|-----------------------|---------------------|-------------------------|--|
| 1,4 | N/C ² | No Connection | |
| 2 | С | Logic Control Input | |
| 3 | V _{CC} | Logic Bias | |
| 5 | GND | Ground | |
| 6,7,9,10, 12,14,15 | N/C ³ | No Connection | |
| 8 | А | Output A | |
| 11 | V_{DD} | High Voltage Bias | |
| 13 | В | Output B | |
| 16 | GND | Ground | |
| 17 | Paddle ⁴ | Ground | |

- 2. Pin 1 and Pin 4 (N/C) can be grounded if desired.
- Pins 6, 7, 9, 10, 12, 14 and 15 (N/C) should be isolated on the PCB to prevent voltage difference between adjacent pins from exceeding IPC 2221 standard. For V_{DD} peak voltage less than 30 V, these pins can be grounded if desired.
- 4. The exposed pad centered on the package bottom must be connected to the RF, DC and thermal ground.

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^{*} Restrictions on Hazardous Substances, European Union Directive 2011/65/EU

MADR-009150



20 - 50 V Driver for High Power PIN Diode Switches

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Electrical Specifications: $T_A = 25$ °C, $V_{CC} = 3.3$ V, $V_{DD} = 50$ V

| Parameter | Test Conditions | Units | Min. | Тур. | Max. |
|--------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|-------|------|--------------------------|------|
| V _{CC} Quiescent Current | C = 3.3 V | μA | _ | 50 | _ |
| V _{DD} Quiescent Current | C = 0 V or 3.3 V | mA | _ | 0.5 | _ |
| Control Input Leakage Current ⁵ | C = 3.3 V | μA | _ | 25 | _ |
| RPULL-UP, Output Pull-up On Resistance | 100 mA Load | Ω | _ | 19 | _ |
| RPULL-DOWN, Output Pull-down On Resistance | 200 mA Load | Ω | _ | 6 | _ |
| Switching Speed Driving 100 pF Capacitors 6 $T_{\rm ON}$ $T_{\rm OFF}$ $T_{\rm RISE}$ $T_{\rm FALL}$ | 50% control to 90% Voltage 50% control to 10% Voltage 10% to 90% Voltage 90% to 10% Voltage | ns | _ | 120 140 30 30 | _ |
| Switching Speed Driving the MASW-000936 Switch 7 T_{ON} T_{OFF} T_{RISE} T_{FALL} | 50% control to 90% RF 50% control to 10% RF 50% control to 90% RF 50% control to 10% RF | ns | _ | 320 300 420 160 | _ |
| Driver Power Up Time | Note 8 | μs | _ | 30 | |
| Driver Power Down Time | Note 9 | μs | _ | 500 | _ |

^{5.} This leakage current is due to an active pull-down NMOS FET at the control input.

^{6.} During this test, there was 100 pF capacitive load at each output (no current load).

MACOM MASW-000936 is a 120 W SPDT PIN diode switch requiring 100 mA current to bias series and shunt diodes. These results were
measured with a 2.7 GHz, 9.5 dBm sine wave signal.

^{8.} The driver power up time is the time needed for the internal bias voltages to reach 90% of their steady state value during power up.

^{9.} The driver power down time is the time needed for the internal voltages to discharge to 10% of their steady state value during power down.



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Recommended Operating Conditions

| Parameter | Test Conditions | Units | Min. | Тур. | Max. |
|---------------------------------------------------|------------------------|-------|------------|------------------------|------------------------|
| V _{CC} | _ | V | 3.0 | 3.3 | 3.6 |
| V_{DD} | _ | V | 20 | _ | 50 |
| С | Logic "0" Logic "1" | V | 0.0 2.0 | 0.0 V _{CC} | 0.8 V _{CC} |
| I _{SINK} , Sinking Current per Output | _ | mA | _ | _ | 200 |
| I _{SOURCE} , Sourcing Current per Output | _ | mA | _ | _ | 100 |
| Total Capacitive load per Output (Operating) | _ | pF | _ | _ | 100 |
| Operating Temperature | _ | °C | -40 | +25 | +85 |

Absolute Maximum Ratings^{10,11}

| Parameter | Absolute Maximum | |
|-------------------------------|-----------------------------------|--|
| V _{CC} | -0.5 V ≤ V _{CC} ≤ +5.5 V | |
| V _{DD} | -0.5 V ≤ V _{DD} ≤ +55 V | |
| С | -0.5 V ≤ V _{CC} ≤ +5.5 V | |
| Sinking Current per Output | 250 mA | |
| Sourcing Current per Output | 125 mA | |
| Capacitive Load per Output 12 | 125 pF | |
| Operating Temperature | -40°C to +110°C | |
| Storage Temperature | -55°C to +150°C | |

^{10.} Exceeding any one or combination of these limits may cause permanent damage to this device.

Logic Truth Table

| Input C | Output A | Output B |
|---------|---------------------------------|---------------------------------|
| 0 | ≈ GND ¹³ | ≈ V _{DD} ¹⁴ |
| 1 | ≈ V _{DD} ¹⁴ | ≈ GND ¹³ |

^{13.} The actual output low voltage can be calculated by: V_{OL} = I_{SINK} x $R_{Pull-Down}$.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM classification 1C devices.

MACOM does not recommend sustained operation near these survivability limits.

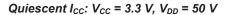
Capacitive load above 125 pF can cause peak current exceeding power limit for the MOSFETs in the output buffer.

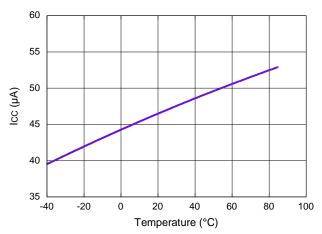
^{14.} The actual output low voltage can be calculated by: V_{OH} = V_{DD} - I_{SOURCE} x $R_{Pull-Up}$.



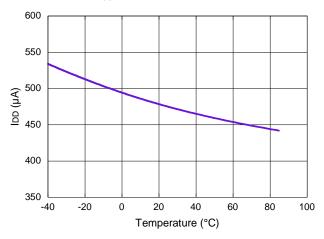
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Typical Performance Curves

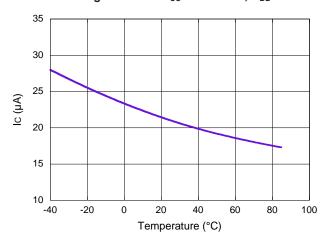




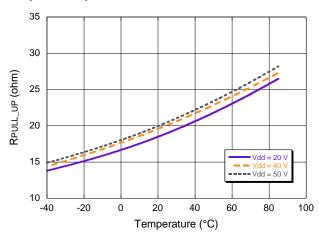
Quiescent I_{DD} : $V_{CC} = 3.3 \text{ V}$, $V_{DD} = 50 \text{ V}$



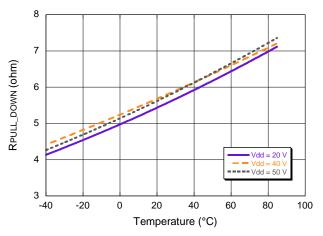
Control Leakage Current: $V_{CC} = C = 3.3 \text{ V}$, $V_{DD} = 50 \text{ V}$



Output Pull-up On Resistance: Vcc = 3.3 V



Output Pull-down On Resistance: $V_{CC} = 3.3 \text{ V}$



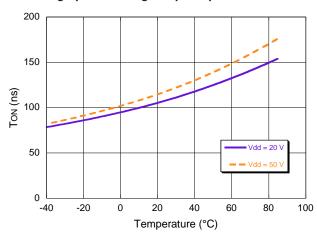
4



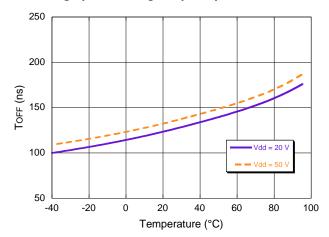
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Typical Performance Curves¹⁵

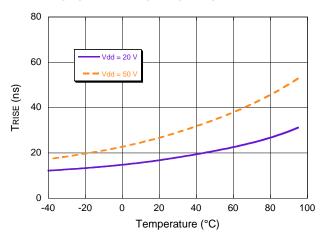
Switching Speed Driving 100 pF Capacitors: Ton



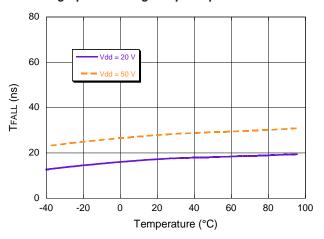
Switching Speed Driving 100 pF Capacitors: Toff



Switching Speed Driving 100 pF Capacitors: TRISE



Switching Speed Driving 100 pF Capacitors: TFALL



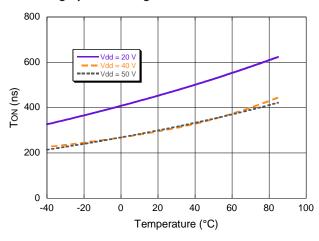
15. During this test, there was 100 pF capacitive load at each output (no current load). V_{CC} = 3.3 V. Control input was a 0 V to 3.3 V pulse with rise and fall time of 6 ns.



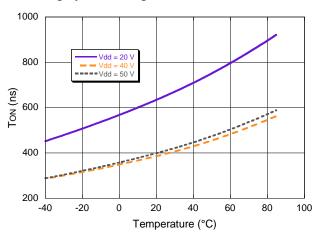
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Typical Performance Curves¹⁶

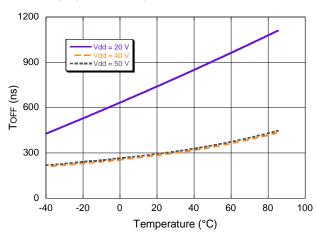
Switching Speed Driving MASW-000936: Tx ON



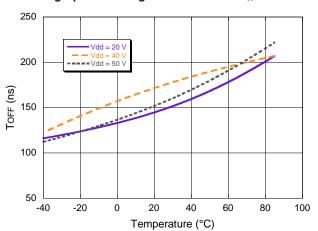
Switching Speed Driving MASW-000936: Rx ON



Switching Speed Driving MASW-000936: Tx OFF



Switching Speed Driving MASW-000936: Rx OFF

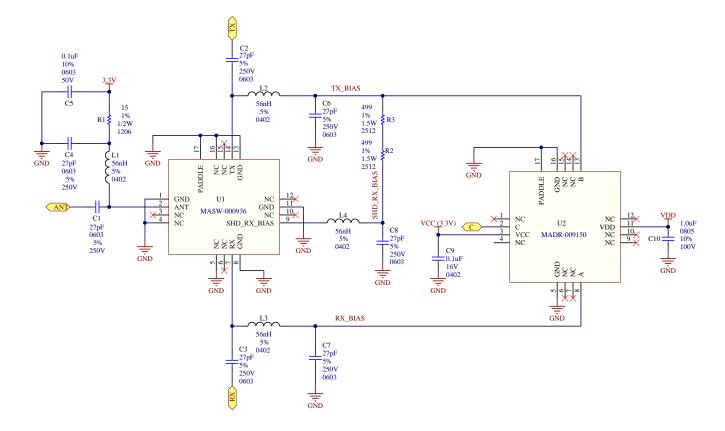


16. MACOM's MASW-000936 is a 120 W SPDT PIN diode switch requiring 100 mA current to bias series and shunt diodes. These results were measured with a 2.7 GHz, 9.5 dBm sine wave signal. Control input was a 0 V to 3.3 V pulse with rise and fall time of 6 ns.



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Application Circuit: Driving PIN Diode Switch MASW-000936^{17,18}

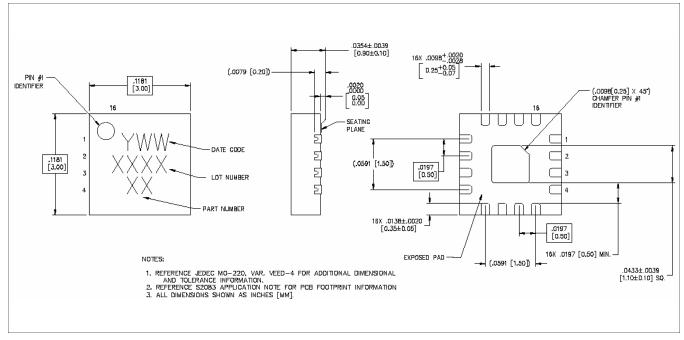


- 17. This application circuit is configured to bias the series diodes of the MASW-000936 switch with 100 mA current. Shunt diode bias current is depending on the value of V_{DD} . With V_{DD} of 40 V, the shunt diode current is around 38 mA.
- 18. This driver can also be used to drive a series/shunt, series/shunt, SP2T switch. RX shunt diode bias should be connected to the TX series diode bias as shown in the schematic above. TX shunt diode bias should be connected to the RX series diode bias. To the driver, the sourcing current is the shunt diode forward bias current. The sinking current is the sum of the shunt diode bias current and the series diode bias current.



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Lead-Free 3 mm 16-Lead PQFN[†]



[†] This is not a JEDEC standard package.

Meets JEDEC moisture sensitivity level 1 requirements.

Plating is NiPdAu.

MADR-009150



20 - 50 V Driver for High Power PIN Diode Switches

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